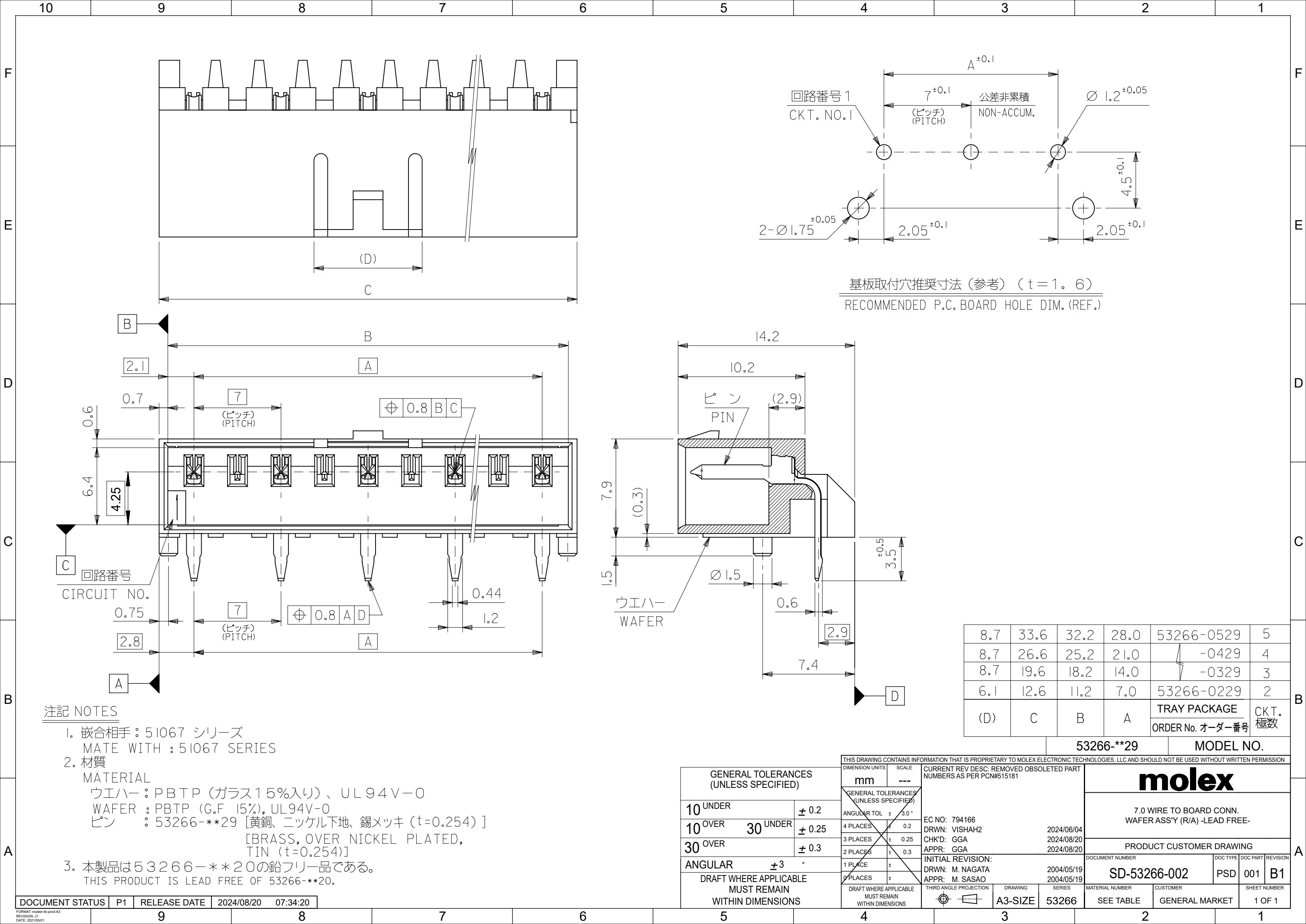


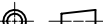


注記 NOTES

1. 嵌合相手 : 51067 シリーズ
MATE WITH : 51067 SERIES
2. 材質
MATERIAL
ウエハー : PBTP (ガラス15%入り)、UL94V-0
WAFER : PBTP (G.F. 15%), UL94V-0
ピン : 53266-**29 [黄銅、ニッケル下地、錫メッキ (t=0.254)]
[BRASS, OVER NICKEL PLATED, TIN (t=0.254)]
3. 本製品は53266-**20の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 53266-**20.

DOCUMENT STATUS	P1	RELEASE DATE	2024/08/20	07:34:20
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FORMAT: master-B-prod-A3
REVISION: 11
DATE: 2021/05/01

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																	
DIMENSION UNITS		SCALE		CURRENT REV DESC: REMOVED OBSOLETE PART NUMBERS AS PER PCN#515181													
mm		---		EC NO: 794166 DRWN: VISHAH2 CHK'D: GGA APPR: GGA INITIAL REVISION: DRWN: M. NAGATA APPR: M. SASAO 2024/06/04 2024/08/20 2024/08/20 2004/05/19 2004/05/19													
GENERAL TOLERANCES (UNLESS SPECIFIED)																	
ANGULAR TOL ± 3.0°																	
4 PLACES ± 0.2																	
3 PLACES ± 0.25																	
2 PLACES ± 0.3																	
1 PLACE ±				7.0 WIRE TO BOARD CONN. WAFER ASS'Y (R/A) -LEAD FREE- PRODUCT CUSTOMER DRAWING													
0 PLACES ±																	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				THIRD ANGLE PROJECTION		DRAWING		SERIES		DOCUMENT NUMBER		DOC TYPE		DOC PART		REVISION	
						A3-SIZE		53266		SD-53266-002		PSD		001		B1	
										MATERIAL NUMBER		CUSTOMER				SHEET NUMBER	
										SEE TABLE		GENERAL MARKET				1 OF 1	